

- CLEAN THE BOARD
- ★ MEASURE AND CUT FILM
- REMOVE COATING AND APPLY FILM
- **+** LAMINATE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML

Part 1

» Make your own presensitized copper clad board

Part 2

» Make your own circuit board



- CLEAN THE BOARD
- ★ MEASURE AND CUT FILM
- REMOVE COATING AND APPLY FILM
- **+** LAMINATE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML Step1 Clean the board. **BACK** NEXT



- CLEAN THE BOARD
- MEASURE AND CUT FILM
- REMOVE COATING AND APPLY FILM
- **+** LAMINATE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML For best results, clean the board using fine steel wool or similar abrasive pad and rinse with water. This will remove dirt, oils, and other contamination. Wear powder-free gloves when working with Negative Dry Film Resist. **BACK** COPPER CLAD BOARD



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FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML Use M.G. Chemicals Super Wash Electronics Cleaner to quick dry board or heat it in an oven for 5 minutes or use a blow dryer. The board must be absolutely clean and dry prior to applying film. Note: After rinse, the board should be dried quickly to avoid oxidation. NEXT



- ♣ CLEAN THE BOARD
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- **+** LAMINATE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML Step2 Measure and cut film. NEXT **BACK**



- MEASURE AND CUT FILM
- REMOVE COATING AND APPLY FILM
- **+** LAMINATE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML Work in a safe light environment when handling the film - any exposure to UV light will expose the film. Safe light refers to any incandescent bulb less than 40 watts. NEXT **BACK**



- + CLEAN THE BOARD
- MEASURE AND CUT FILM
- REMOVE COATING AND APPLY FILM
- **+** LAMINATE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML Sharp scissors work best for cutting this film. The amount of film required depends on the size of the board being laminated. A 1 cm border should be left on all sides of the board due to shrinkage from heat. NEXT BACK



- + CLEAN THE BOARD
- MEASURE AND CUT FILM
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- **+** LAMINATE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML For double sided boards, cut the film big enough (one piece) to sandwich the board in the middle. For a double-sided board, you will only have the 1 cm border on 3 sides. No border is required for the side where the film meets the board. NEXT **BACK**



- CLEAN THE BOARD
- ★ MEASURE AND CUT FILM
- REMOVE COATING AND APPLY FILM
- **+** LAMINATE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML Step3 Remove protective coating and apply film. **BACK**



- CLEAN THE BOARD
- MEASURE AND CUT FILM
- REMOVE COATING AND APPLY FILM
- **+** LAMINATE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML First peel off the protective coating (on the side with the sticker - the soft hazy side). Apply the film face down with the side that just had the film removed.

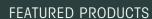


- + CLEAN THE BOARD
- MEASURE AND CUT FILM
- REMOVE COATING AND APPLY FILM
- **+** LAMINATE

Fold back the film on the side that will be fed into the laminator. It is important that the film is wrinkle free. For a double-sided board, no folding is required as the board is already sandwiched between the film.

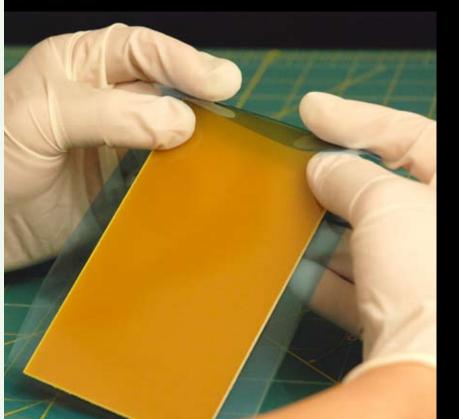
BACK

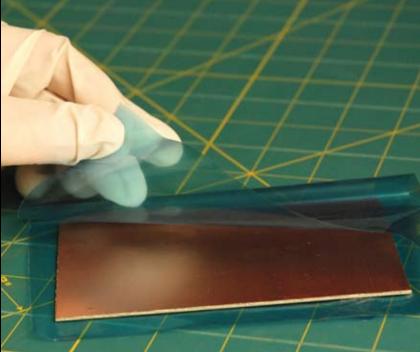
NEXT



Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML







- CLEAN THE BOARD
- ★ MEASURE AND CUT FILM
- ♣ REMOVE COATING AND APPLY FILM
- **+** LAMINATE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML

Step 4 Laminate. **BACK** NEXT



- CLEAN THE BOARD
- MEASURE AND CUT FILM
- REMOVE COATING AND APPLY FILM
- **+** LAMINATE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML

Turn on the laminator. Wait until the laminator 'ready' indicator is on. Feed the board with the film side facing up into the laminator. Feed the side of the board with the excess border folded back. **BACK NEXT**



- + CLEAN THE BOARD
- MEASURE AND CUT FILM
- REMOVE COATING AND APPLY FILM
- **+** LAMINATE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML

Once the board finishes laminating, put it through the laminator for a second time immediately after the first run (if required). The process is the same for the double-sided board. Store finished board in a dark and dust free environment until ready for use. **BACK** NEXT

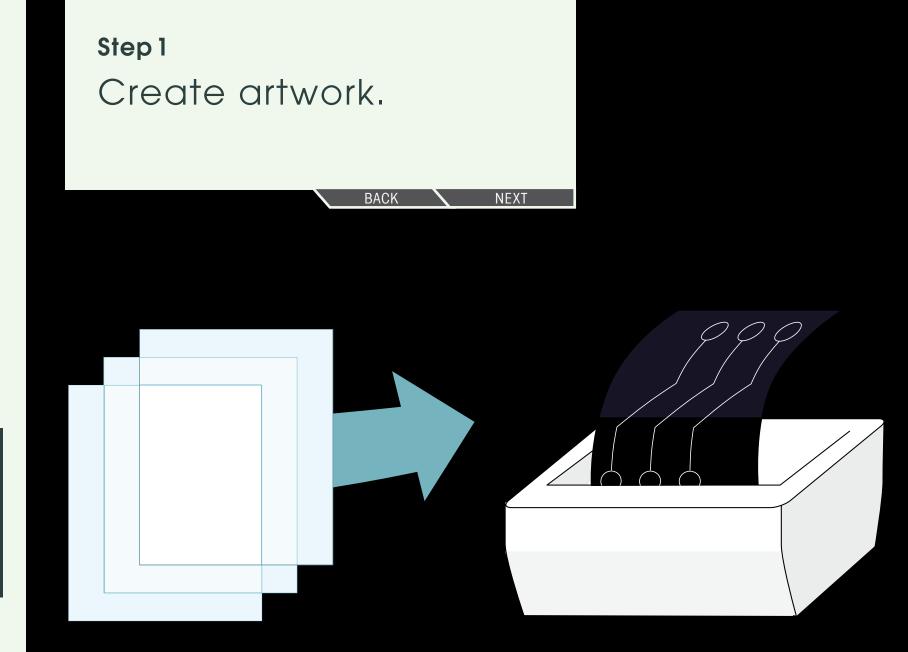


- **+** EXPOSE
- ◆ DEVELOP
- **♣** RINSE
- **+** ETCH
- ♣ RINSE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML





- **+** EXPOSE
- DEVELOP
- **★** RINSE
- **+** ETCH
- ♣ RINSE

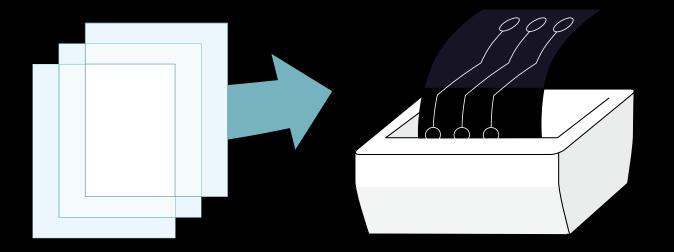
FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML Print artwork on Transparency Film (MG Cat. No. 416-T) using a 600 dpi or higher resolution laser printer.

BACK

NEXT





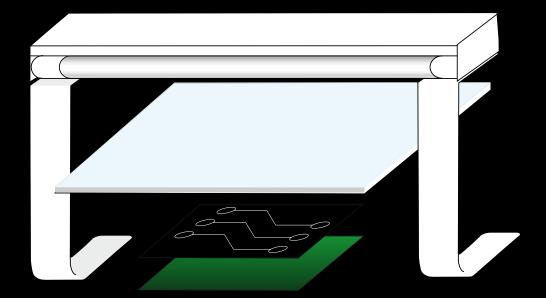
- **+** EXPOSE
- ◆ DEVELOP
- **♣** RINSE
- **+** ETCH
- ♣ RINSE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML Step 2
Expose.

BACK NEXT





- ♣ CREATE ARTWORK
- **+** EXPOSE
- DEVELOP
- **+** RINSE
- **+** ETCH
- ♣ RINSE

FEATURED PRODUCTS

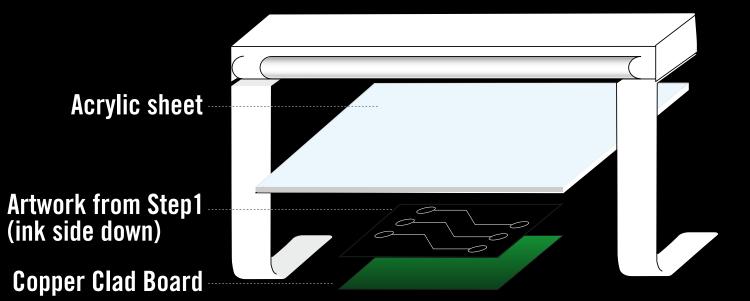
Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML

www.mgchemicals.com

Expose artwork onto the presensitized copper clad board using Exposure Kit (M.G. Cat. No. 416-X) for 12 minutes.

BACK



NEXT



- **+** EXPOSE
- ◆ DEVELOP
- **★** RINSE
- **+** ETCH
- ♣ RINSE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML

Step3 Develop. BACK NEXT Developer



- ♣ CREATE ARTWORK
- **+** EXPOSE
- DEVELOP
- ➡ RINSE
- **★** ETCH
- **★** RINSE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML

Peel the second protective covering from board before submerging into solution. Mix developer with room temperature water at 1:10 ratio. Brush board lightly with foam brush in developer solution. Develop board in solution for approximately 1-2 minutes. Monitor visually. **BACK** NEXT Developed Board Developer .

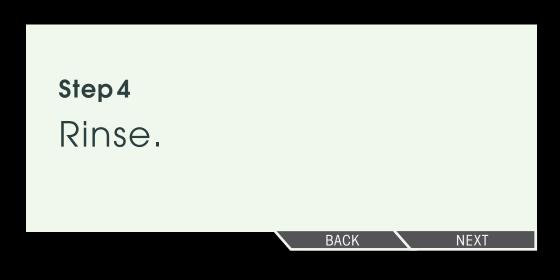


- **+** EXPOSE
- ◆ DEVELOP
- **♣** RINSE
- **+** ETCH
- ♣ RINSE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML







- ♣ CREATE ARTWORK
- **+** EXPOSE
- ◆ DEVELOP
- **★** RINSE
- **+** ETCH
- ♣ RINSE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

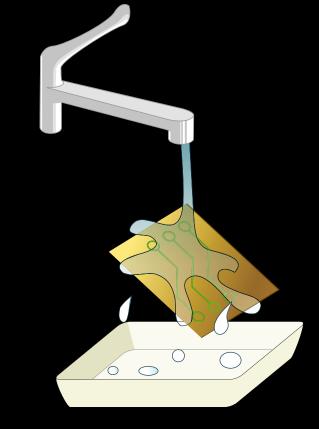
Negative Developer Cat. No. 4170-500ML

www.mgchemicals.com

Rinse with cold tap water. It is important that the board is rinsed thoroughly.

BACK

NEXT





- ♣ CREATE ARTWORK
- **+** EXPOSE
- ◆ DEVELOP
- **+** RINSE
- **+** ETCH
- ♣ RINSE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML Step 5 Etch.

CHOOSE AN ETCHANT.

AVAILABLE ETCHING KITS.



- ♣ CREATE ARTWORK
- **+** EXPOSE
- DEVELOP
- **+** RINSE
- **★** ETCH
- ♣ RINSE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML

www.mgchemicals.com

Available Etching Kits

Economy Etching Kit (Cat. No. 416-ES)
Professional Etching Process Kit
(Cat. No. 416-E)

BACK

NEXT

CHOOSE AN ETCHANT.

Ferric Chloride

Ready to use solution. 42° Baume.

Ammonium Persulphate

Not compatible with etch resist pens. Dilution required.

Sodium Persulphate

Dilution required.



- ♣ CREATE ARTWORK
- **+** EXPOSE
- ◆ DEVELOP
- ♣ RINSE
- **+** ETCH
- **★** RINSE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML Etch for 10 - 30 minutes (heat solution to 45°C/113°F). Wear gloves, eyegear, and protective clothing.

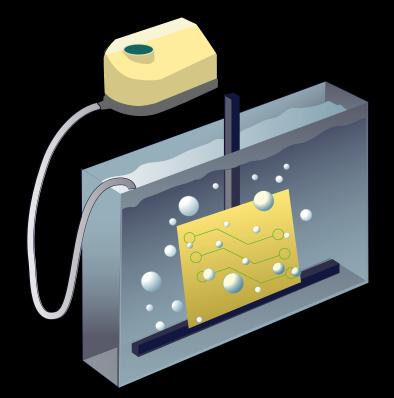
The tank fits two 8" x 9" double sided Copper Clad Boards. The kit is ideal for students and hobbyists.

BACK

NEXT

ECONOMY
ETCHING PROCESS
KIT

Cat. No. 416-ES





- ♣ CREATE ARTWORK
- **+** EXPOSE
- ◆ DEVELOP
- ♣ RINSE
- **+** ETCH
- ♣ RINSE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML Etch for 10 - 30 minutes (heat solution to 45°C/113°F). Wear gloves, eyegear, and protective clothing.

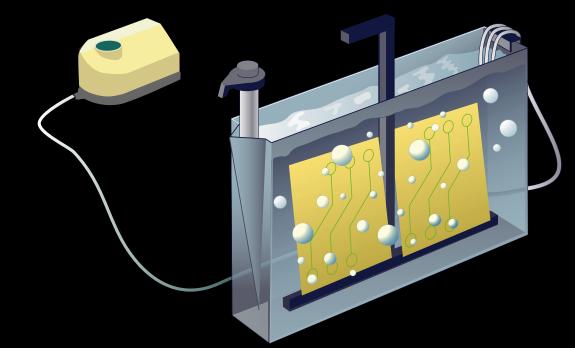
The tank fits two 8" x 12" double sided Copper Clad Boards. The kit is ideal for professional use.

BACK

NEXT

PROFESSIONAL
ETCHING PROCESS
KIT

Cat. No. 416-E





- ♣ CREATE ARTWORK
- **+** EXPOSE
- ◆ DEVELOP
- **+** RINSE
- **+** ETCH
- **+** RINSE

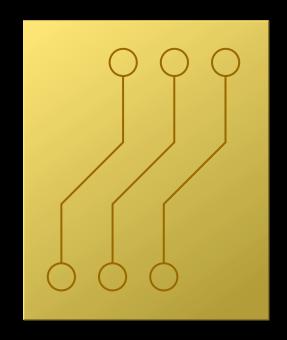
FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML End result of a etched board after the etching process.

BACK

NEXT



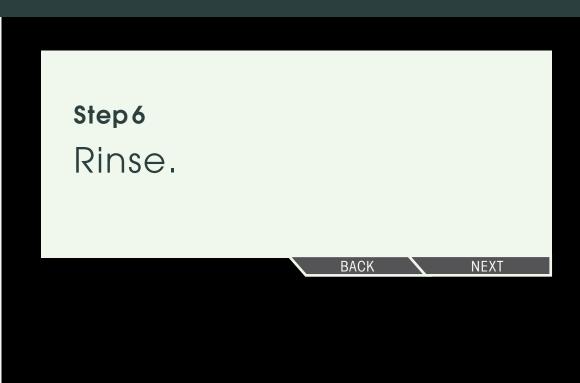


- ♣ CREATE ARTWORK
- **+** EXPOSE
- ◆ DEVELOP
- **♣** RINSE
- **+** ETCH
- ♣ RINSE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML





- ♣ CREATE ARTWORK
- **+** EXPOSE
- DEVELOP
- ♣ RINSE
- **+** ETCH
- ♣ RINSE

FEATURED PRODUCTS

Negative Dry Film Resist Cat. No. 416DFR-5

Negative Developer Cat. No. 4170-500ML

